

Part Number: XZ80S-2MU63

2.2x1.4mm SURFACE MOUNT LED LAMP

Features

- Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- ullet RoHS compliant







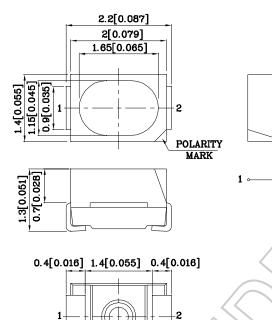
ATTENTION

OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Applications

- Backlighting for tell-tale indicators
- Dashboard lighting
- Interior lighting (footwell, dome light, accent lighting, etc.)
- Exterior lighting (turn signals, side markers, CHMSL, etc.)
- Signs and signals
- Various applications requiring high temperature rating

Package Schematics



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.



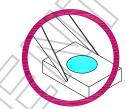


Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

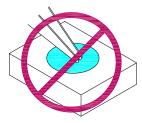
As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.

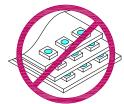


2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

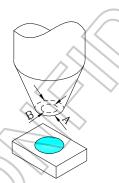




3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



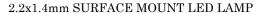
- 4.1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4.2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4.3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.

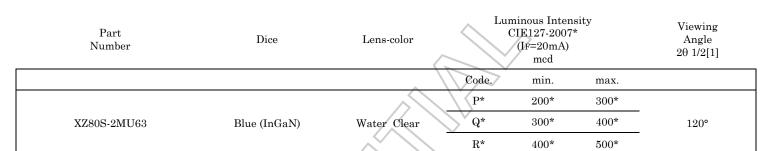


5. As silicone encapsulation is permeable to gases, some corrosive substances such as H_2S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.



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Note:

Absolute Maximum Ratings at Ta=25°C

| Parameter | Symbol | Value | Unit |
|---|---------|-------------|------|
| Power dissipation | PD | 120 | mW |
| Reverse Voltage | VR | 5 | V |
| Junction temperature[1] | TJ | 115 | °C |
| Operating Temperature | Top | -40 To +100 | °C |
| Storage Temperature | Tstg | -40 To +110 | °C |
| DC Forward Current[1] | IF | 30 | mA |
| Peak Forward Current [2] | IFM | 100 | mA |
| Electrostatic Discharge Threshold (HBM) | | 250 | V |
| Thermal Resistance (Junction/ambient) [1] | Rth j-a | 570 | °C/W |

Notes:

Electrical / Optical Characteristics at Ta=25°C

| Parameter | Samp of | Value | | | Unit | |
|--|----------|-------|------|-------------|------|-------|
| rarameter | Symbol | Code. | Min. | Typ. | Max. | Onit |
| Wavelength at peak emission CIE127-2007* IF=20mA | λpeak | | ~ | 465* | | nm |
| | | 1A* | 460* | | 463* | |
| | | 1B* | 463* | 1 | 466* | |
| Dominant Wavelength CIE127-2007* IF=20mA | λdom [1] | 2A* | 466* | > | 469* | nm |
| | | 2B* | 469* | | 471* | |
| | | 3A* | 471* | | 473* | |
| Spectral bandwidth at 50%Φ RELMAX IF=20mA [Typ.] | Δλ | | | 22 | | nm |
| Forward Voltage IF=20mA | VF [2] | | | 3.3 | 4.0 | V |
| Reverse Current (VR = 5V) | I.R. | | | | 50 | uA |
| Temperature coefficient of λpeak IF=20mA, -10°C≤ T≤100°C [Typ.] | TCλpeak | | | 0.06 | | nm/°C |
| Temperature coefficient of λdom I _F =20mA, -10°C≤ T≤100°C [Typ.] | TCλdom | | | 0.03 | | nm/°C |
| Temperature coefficient of VF IF=20mA, -10°C≤ T≤100°C | TCv | | | -2.2 | | mV/°C |

^{*}Wavelength value is in accordance with CIE127-2007 standards.

 $^{1.\,\}theta 1/2$ is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

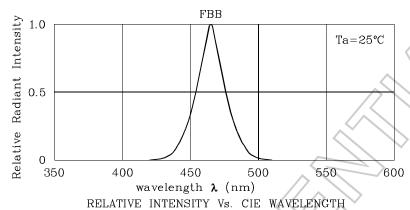
^{*} luminous intensity value is in accordance with CIE127-2007 standards.

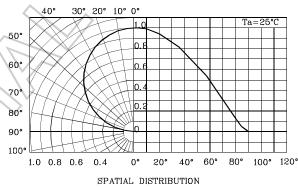
^{1.} Rth(j-a) Results from mounting on PC board FR4 (pad size≥16 mm² per pad),

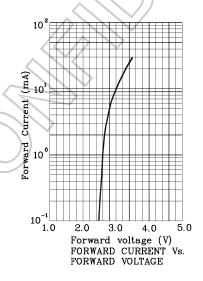
^{2. 1/10} Duty Cycle, 0.1ms Pulse Width.

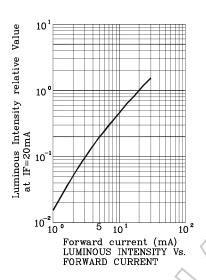


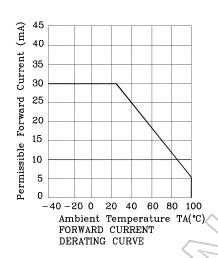


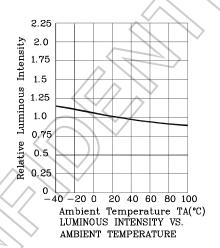








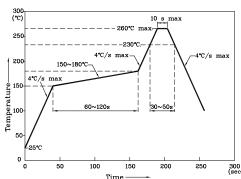






LED is recommended for reflow soldering and soldering profile is shown below.

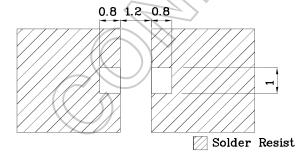
Reflow Soldering Profile For Lead-free SMT Process.



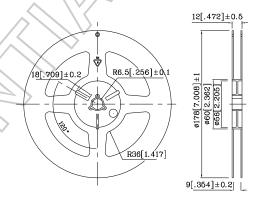
- NOTES:

 1. Maximum soldering temperature should not exceed 260°c.
 - 2. Recommended reflow temperature: 145°c-260°c
 - 3. Do not put stress to the epoxy resin during high

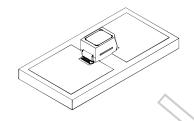
* Recommended Soldering Pattern (Units: mm; Tolerance: ±0.1)



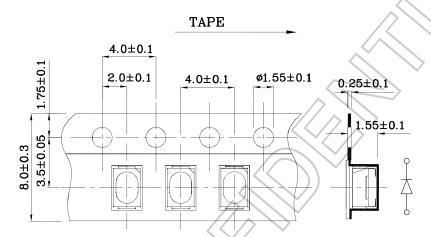
* Reel Dimension



❖ The device has a single mounting surface. The device



❖ Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

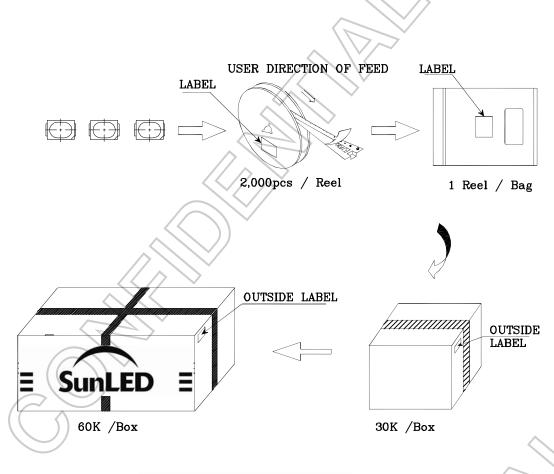
Note: Accuracy may depend on the sorting parameters.

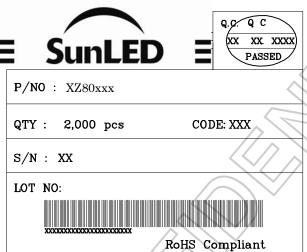
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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below

Lot Tolerance Percent Defective (LTPD): 10%

| No. | Test Item | Standards | Test Condition | Test Times / Cycles | Number of Damaged |
|-----|--------------------------------------|----------------------|---|------------------------|----------------------|
| 1 | Continuous operating test | - | Ta =25°C ,IF = maximum rated current* | 1,000 h | 0 / 22 |
| 2 | High Temp. operating test | EIAJED-4701/100(101) | Ta = 100°C IF = derated current at 100°C | 1,000 h | 0 / 22 |
| 3 | Low Temp. operating test | | Ta = -40°C, IF = maximum rated current* | 1,000 h | 0 / 22 |
| 4 | High temp. storage test | EIAJED-4701/100(201) | Ta = maximum rated storage temperature | 1,000 h | 0 / 22 |
| 5 | Low temp. storage test | EIAJED-4701/100(202) | Ta = -40°C | 1,000 h | 0 / 22 |
| 6 | High temp. & humidity storage test | | Ta = 60°C, RH = 90% | 500 h | 0 / 22 |
| | High temp. & humidity operating test | - | Ta = 60°C, RH = 90% IF = derated current at 60°C | 500 h | 0 / 22 |
| 8 | Soldering reliability test | EIAJED-4701/100(301) | Moisture soak : 30°C,70% RH, 72h Preheat : 150~180°C(120s max.) Soldering temp : 260°C(10s) | 2 times | 0 / 18 |
| 9 | Thermal shock operating test | - | Ta = -40°C(15min) ~ 100°C(15min) IF = derated current at 100°C | 1,000 cycles | 0 / 22 |
| 10 | Thermal shock test | - | Ta = -40°C(15min) ~ 100°C(15min) | 1,000 cycles | 0 / 22 |
| 11 | Electric Static Discharge (ESD) | EIAJED-4701/100(304) | $C = 100 pF$, $R2 = 1.5 K\Omega$ $V = 250 V$ | Once each Polarity | 0 / 22 |
| 12 | Vibration test | - | $a = 196 \text{m/s}^2$, $f = 100 \sim 2 \text{KHz}$, t = 48 min for all xyz axes | 4 times | 0 / 22 |

st: Refer to forward current vs. derating curve diagram

Failure Criteria

| Items | Symbols | Conditions | Failure Criteria |
|-------------------------|---------|------------------------------------|---|
| luminous Intensity | lv | $I_F = 20 \text{mA}$ | Testing Min. Value <spec.min.value 0.5<="" td="" x=""></spec.min.value> |
| Forward Voltage | VF | $I_F = 20 \text{mA}$ | Testing Max. Value ≥Spec.Max.Value x 1.2 |
| Reverse Current | Ir | VR = Maximum Rated Reverse Voltage | Testing Max. Value ≥Spec.Max.Value x 2.5 |
| High temp. storage test | - | | Occurrence of notable decoloration, deformation and cracking |